

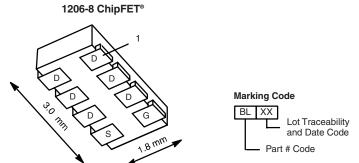
P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
	0.037 at $V_{GS} = -4.5 \text{ V}$	- 6.7			
- 20	0.050 at V _{GS} = - 2.5 V	- 5.9	15		
	0.070 at V _{GS} = - 1.8 V	- 5.0			

FEATURES

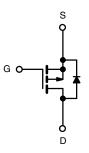
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET





Ordering Information: Si5433BDC-T1-E3 (Lead (Pb)-free)

Si5433BDC-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 20		V
Gate-Source Voltage		V_{GS}	± 8		
Ocaliana Desir Ocara (T. 150.00)3	T _A = 25 °C	- I _D	- 6.7	- 4.8	٨
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 4.8	- 3.5	
Pulsed Drain Current		I _{DM}	- 20		Α
Continuous Source Current ^a		I _S	- 2.1	- 1.1	
	T _A = 25 °C	P _D	2.5	1.3	W
Maximum Power Dissipation ^a	T _A = 85 °C		1.3	0.7	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b, c}				260	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manipulation to Applicate	t ≤ 5 s	В	45	50	°C/W	
Maximum Junction-to-Ambient ^a	Steady State	R_{thJA}	85	95		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	20]	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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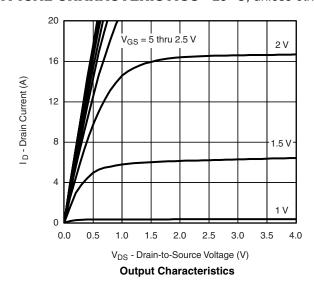
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•		•				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45		- 1.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	1	V _{DS} = - 20 V, V _{GS} = 0 V			- 1		
	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 85 °C			- 5	- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 4.8 A		0.030	0.037	Ω	
		V _{GS} = - 2.5 V, I _D = - 4.2 A		0.041	0.050		
		V _{GS} = - 1.8 V, I _D = - 1 A		0.056	0.070		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 4.8 A		18		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1.1 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Dynamic ^b			•	•			
Total Gate Charge	Q_g			15	22		
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.8 \text{ A}$		2.4		nC	
Gate-Drain Charge		d		3.6			
Gate Resistance	R_g			10		Ω	
Turn-On Delay Time	t _{d(on)}			12	25		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		25	40		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 6 Ω		80	120	ns	
Fall Time	t _f			55	85		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.1 A, dl/dt = 100 A/μs		30	60		

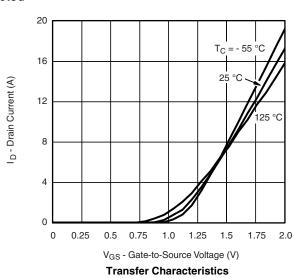
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



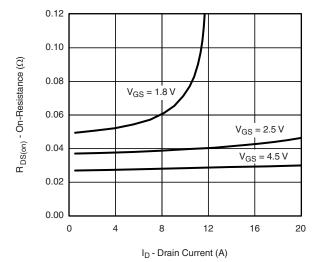




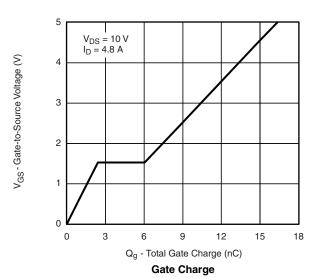


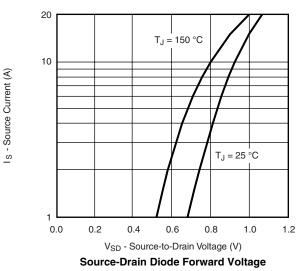


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current

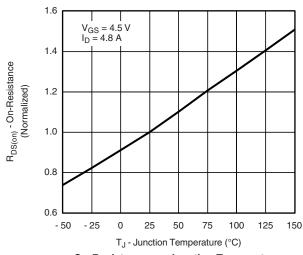




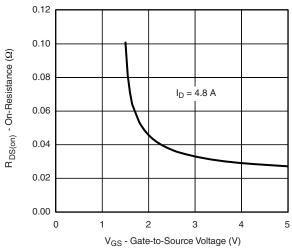
1800 1600 1400 C - Capacitance (pF) 1200 C_{iss} 1000 800 600 400 C_{oss} 200 0 0 8 16

V_{DS} - Drain-to-Source Voltage (V)





On-Resistance vs. Junction Temperature

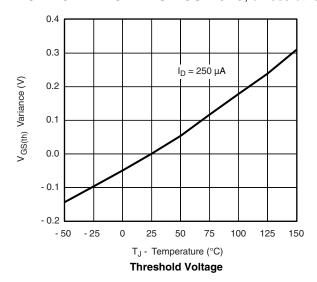


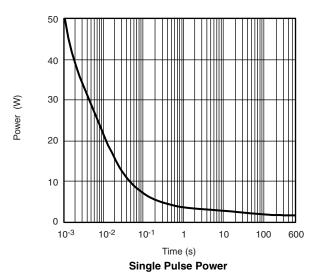
On-Resistance vs. Gate-to-Source Voltage

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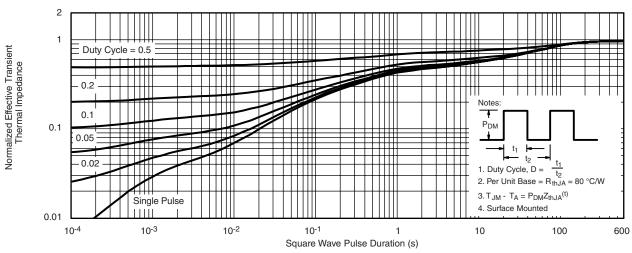
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





(V) = 0.0001 $V_{DS} - Drain-to-Source Voltage (V)$ $V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified$ $V_{DS} - Drain-to-Source Voltage (V)$

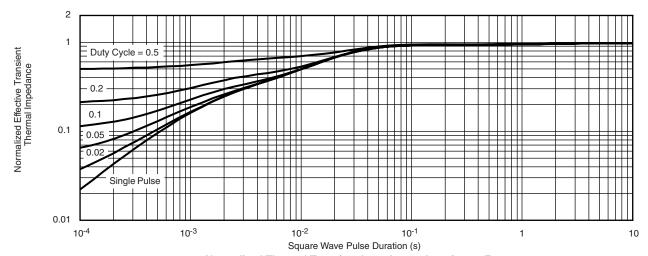
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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